

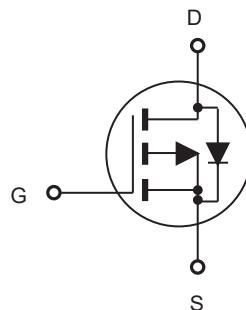


# CEP90P04/CEB90P04

## P-Channel Enhancement Mode Field Effect Transistor

### FEATURES

- -40V, -89A,  $R_{DS(ON)} = 7.1\text{m}\Omega$  @ $V_{GS} = -10\text{V}$ .  
 $R_{DS(ON)} = 11\text{m}\Omega$  @ $V_{GS} = -4.5\text{V}$ .
- Super high dense cell design for extremely low  $R_{DS(ON)}$ .
- High power and current handing capability.
- RoHS compliant.
- TO-220 & TO-263 package.

CEB SERIES  
TO-263(DD-PAK)CEP SERIES  
TO-220

### ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Limit	Units
Drain-Source Voltage	$V_{DS}$	-40	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current-Continuous @ $T_C = 25^\circ\text{C}$ @ $T_C = 100^\circ\text{C}$	$I_D$	-89 -56	A
Drain Current-Pulsed <sup>a</sup>	$I_{DM}$	-356	A
Maximum Power Dissipation @ $T_C = 25^\circ\text{C}$ - Derate above 25 °C	$P_D$	89 0.71	W W/°C
Single Pulsed Avalanche Energy <sup>d</sup>	$E_{AS}$	338	mJ
Single Pulsed Avalanche Current <sup>d</sup>	$I_{AS}$	26	A
Operating and Store Temperature Range	$T_J, T_{stg}$	-55 to 150	°C

### Thermal Characteristics

Parameter	Symbol	Limit	Units
Thermal Resistance, Junction-to-Case	$R_{JC}$	1.4	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{JA}$	62.5	°C/W



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## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_{\text{D}} = -250\mu\text{A}$	-40			V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = -40\text{V}, V_{\text{GS}} = 0\text{V}$			-1	$\mu\text{A}$
Gate Body Leakage Current, Forward	$I_{\text{GSSF}}$	$V_{\text{GS}} = 20\text{V}, V_{\text{DS}} = 0\text{V}$			100	nA
Gate Body Leakage Current, Reverse	$I_{\text{GSSR}}$	$V_{\text{GS}} = -20\text{V}, V_{\text{DS}} = 0\text{V}$			-100	nA
<b>On Characteristics<sup>b</sup></b>						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{GS}} = V_{\text{DS}}, I_{\text{D}} = -250\mu\text{A}$	-1		-3	V
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = -10\text{V}, I_{\text{D}} = -20\text{A}$		5.9	7.1	$\text{m}\Omega$
		$V_{\text{GS}} = -4.5\text{V}, I_{\text{D}} = -20\text{A}$		8	11	$\text{m}\Omega$
<b>Dynamic Characteristics<sup>c</sup></b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}} = -20\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0 \text{ MHz}$		3585		pF
Output Capacitance	$C_{\text{oss}}$			540		pF
Reverse Transfer Capacitance	$C_{\text{rss}}$			170		pF
<b>Switching Characteristics<sup>c</sup></b>						
Turn-On Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = -20\text{V}, I_{\text{D}} = -1\text{A}, V_{\text{GS}} = -10\text{V}, R_{\text{GEN}} = 6\Omega$		36		ns
Turn-On Rise Time	$t_r$			20		ns
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$			245		ns
Turn-Off Fall Time	$t_f$			64		ns
Total Gate Charge	$Q_g$	$V_{\text{DS}} = -20\text{V}, I_{\text{D}} = -20\text{A}, V_{\text{GS}} = -4.5\text{V}$		54		nC
Gate-Source Charge	$Q_{\text{gs}}$			18		nC
Gate-Drain Charge	$Q_{\text{gd}}$			28		nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Drain-Source Diode Forward Current	$I_s$				-68	A
Drain-Source Diode Forward Voltage <sup>b</sup>	$V_{\text{SD}}$	$V_{\text{GS}} = 0\text{V}, I_s = -20\text{A}$			-1.3	V

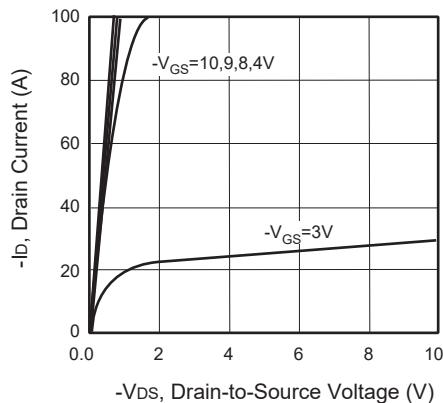
Notes :

a.Repetitive Rating : Pulse width limited by maximum junction temperature.

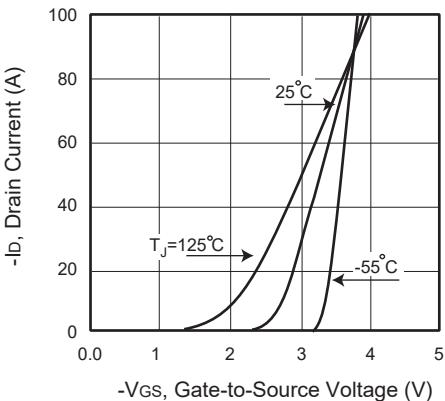
b.Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

c.Guaranteed by design, not subject to production testing.

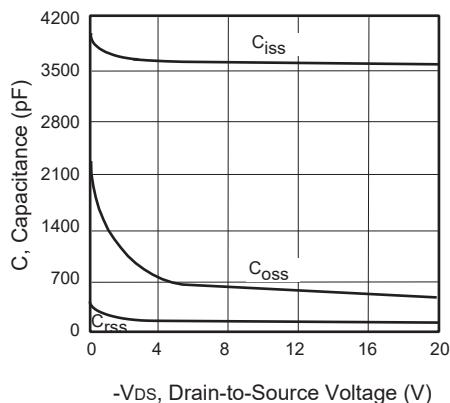
d.L = 1mH,  $I_{AS} = 26\text{A}$ ,  $V_{DD} = 24\text{V}$ ,  $R_G = 25\Omega$ , Starting  $T_J = 25^\circ\text{C}$



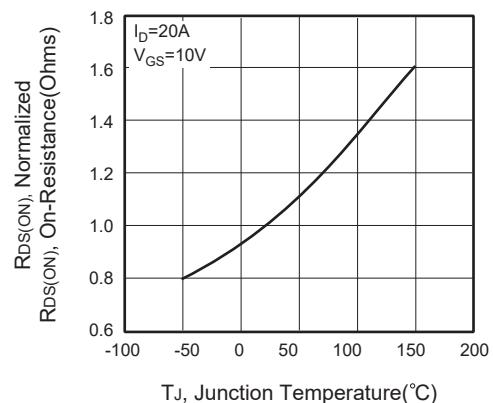
**Figure 1. Output Characteristics**



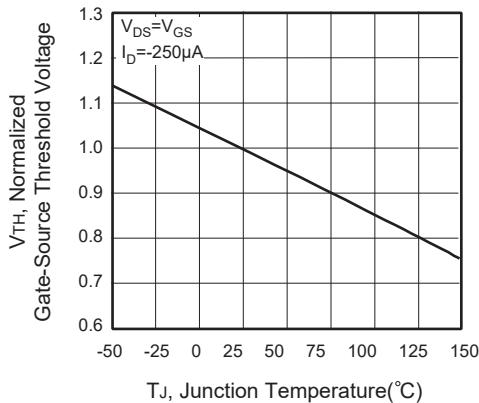
**Figure 2. Transfer Characteristics**



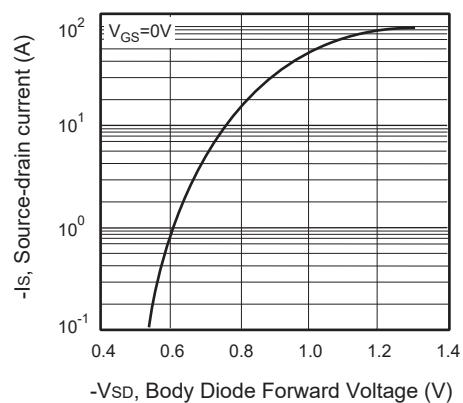
**Figure 3. Capacitance**



**Figure 4. On-Resistance Variation with Temperature**



**Figure 5. Gate Threshold Variation with Temperature**



**Figure 6. Body Diode Forward Voltage Variation with Source Current**

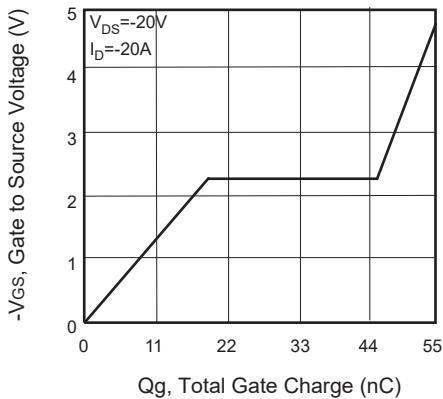


Figure 7. Gate Charge

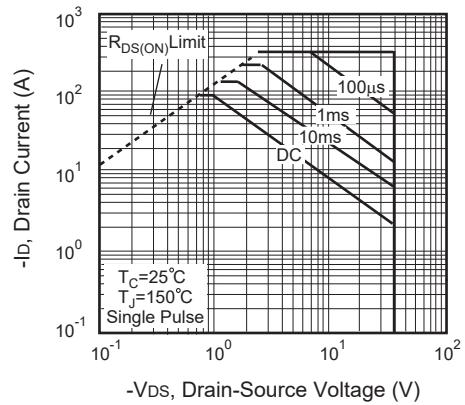


Figure 8. Maximum Safe Operating Area

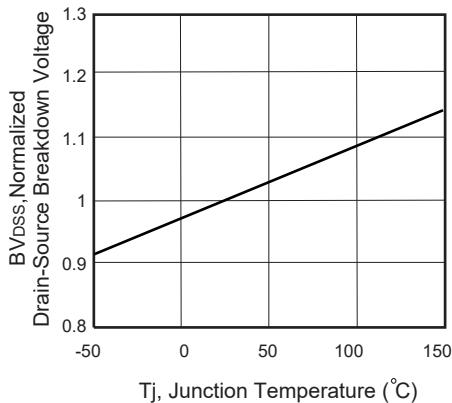


Figure 9. Breakdown Voltage Variation VS Temperature

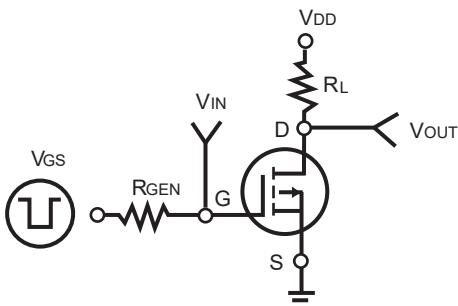


Figure 10. Switching Test Circuit

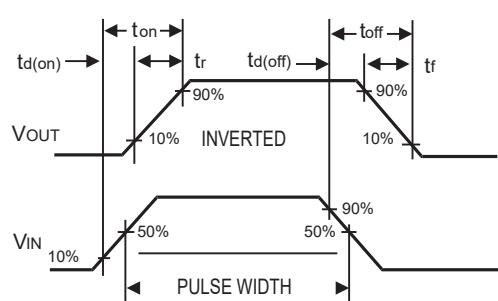


Figure 11. Switching Waveforms



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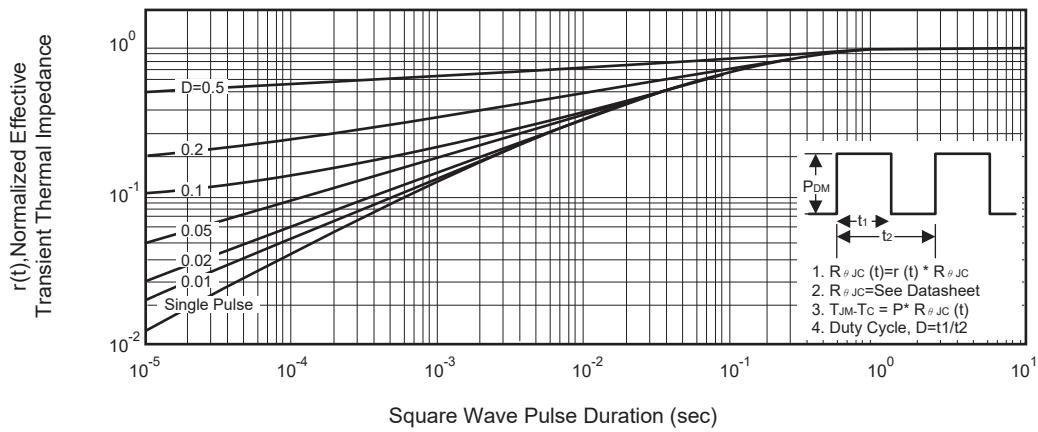


Figure 12. Normalized Thermal Transient Impedance Curve